Docket No. 11759-US

## **Declaration and Power of Attorney For Patent Application**

## **English Language Declaration**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF MAKING HIGH-VOLTAGE BIPOLAR/CMOS/DMOS (BCD) DEVICES

	the specification of which					
: cor	·					
O	(check one)	•				
id T	☑ is attached hereto.					
	□ was filed on	,	as United States Application N	lo. or PCT	International	
	Application Number		<u> </u>			
u	and was amended on _					
! !==	(if applicable)					
	I hereby state that I have reincluding the claims, as ame		tand the contents of the above dment referred to above.	e identified	specification,	
			ed States Patent and Trademas defined in Title 37, Code			
	I hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d) or Section 365(b) of any foreign application(s) for patent or inventor's certificate, or Section 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate or PCT International application having a filing date before that of the application on which priority is claimed.					
	Prior Foreign Application(s)			Priority	Not Claimed	
			*			
	(Number)	(Country)	(Day/Month/Year Filed	<del>-</del>		
	(Number)	(Country)	(Day/Month/Year Filed	i)		
	(Number)	(Country)	(Day/Month/Year Filed	<u>.</u>		
	(IAULIDEL)	(Country)	(Day/Month) real rilet	• /		

(Application Serial No.)	(Filing Date)	<u>-</u>
(Application Serial No.)	(Filing Date)	<del>-</del> '
• •		
(Application Serial No.)	(Filing Date)	-
insofar as the subject matter of ea United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me	ach of the claims of this ap application in the manner of the the duty to disclose to the to be material to patental	provided by the first paragraph or United States Patent and Traden bility as defined in Title 37, C.F.
insofar as the subject matter of ea United States or PCT International U.S.C. Section 112, I acknowledge	ach of the claims of this ap application in the manner of the duty to disclose to the to be material to patental to between the filing date of	g the United States, listed below a pplication is not disclosed in the pprovided by the first paragraph of United States Patent and Traden bility as defined in Title 37, C. F.
insofar as the subject matter of ea United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became availab	ach of the claims of this ap application in the manner of the duty to disclose to the to be material to patental to between the filing date of	g the United States, listed below a pplication is not disclosed in the pprovided by the first paragraph of United States Patent and Traden bility as defined in Title 37, C. F.
insofar as the subject matter of ear United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became availab	ach of the claims of this ap application in the manner of the duty to disclose to the to be material to patental to between the filing date of	g the United States, listed below a pplication is not disclosed in the pprovided by the first paragraph of United States Patent and Traden bility as defined in Title 37, C. F.
insofar as the subject matter of ear United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became availab or PCT International filing date of this	ach of the claims of this ap application in the manner of the duty to disclose to the to be material to patental le between the filing date of is application:	g the United States, listed below a pplication is not disclosed in the pprovided by the first paragraph or United States Patent and Traden bility as defined in Title 37, C. F. of the prior application and the nation (Status)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Richard J. Mitchell	34,519
George M. MacGregor	37,547
Paul S. Sharpe	39,493

Send Correspondence to: Marks & Clerk

P.O. Box 957, Station B Ottawa, ON, K1P 5S7

**CANADA** 

Direct Telephone Calls to: (name and telephone number)

Richard J. Mitchell (613) 236-9561

Stephane Martel	
Sole or first inventor's signature	Date
Residence Granby, Quebec, Canada	
Citizenship CA	
Post Office Address 366 Du Nenuphar, Apt. 2, Granby, Quebec, J2H 2R9, Canada	

Second inventor's signature			Date
Residence Bromont, Quebec, Canada	<u> </u>	<u> </u>	
Citizenship			
Post Office Address 113 Wolfe, Apt. 401, Bromont, Quebec, J2L 1J9, Can	ada		

Sebastien Michel		
Third inventor's signature		Date
Residence Bromont, Quebec, Canada		
Citizenship CA		
Post Office Address 113 Wolfe, Apt. 401, Bromont, Quebec, J2L 1J	9, Canada	
Full name of fourth inventor, if any <b>Luc Ouellet</b>		
Fourth inventor's signature		Date
Residence Granby, Quebec, Canada		
Citizenship CA		
Post Office Address 503 du Rubannier, Granby, Quebec, J2H 2R8, (		
Full name of fifth inventor, if any		
Fifth inventor's signature		Date
Residence		
Citizenship		
Post Office Address	<u> </u>	
		· .
Full name of sixth inventor, if any		
Sixth inventor's signature		Date
Residence		
Citizenship		
Post Office Address		